MRP
5-28-99 Docket No. <u>JCLA4464</u>
Form 1595 RECORD

	ADGODD INTOX DONAL COLUMN	101062320
Form		HEET U.S. Department of Commerce Patent and Trademark Office
Patent and Trademark Office PATENTS ONLY		
A.		
To the Honorable Assistant Commissioner for Patents: Please record the attached original documents or copy thereof.		
1.	Name of conveying party(ies):	2. Name/address of receiving Party(ies):
t	Yongming Li; Hongyi Chen; Xiaodong Wu	Winbond Electronics [H.K.] Ltd
3.	Nature of conveyance: ☐ Assignment ☐ Merger ☐ Security Agreement ☐ Other ☐ Change of Name ☐ Reassignment	Rm. 803, World Trade Square, Tower II, 123 Hoi Bun Road, Kwun Tung, Kowloon,
4.	Date(s) of execution: May 6, 1999.	Hong Kong
		Add'I names of receiving parties Attached? Yes No
5.	5. Application number(s) or patent number(s):	
If this documents is being filed together with a new application, the execution date of the application is May 6, 1999.		
	A. Patent Application No. (s)	B. Patent No. (s)
6.	Additional numbers attached Name and address of party to whom correspondence concerning document should be mailed: J.C. Patents, Inc. 1340 Reynolds Ave., Suite 114 Irvine, CA 92614 (949) 660-0761	? Yes No 7. Total No. of applications and patents involved: ONE(1) 8. Total fee (37 CFR §3.41): \$40.00 Enclosed Charge to Acct. No. 9. Total number of pages, including cover sheet, attachments and document 3.
DO NOT USE THIS SPACE		
10.	. Statement and Signature: To the best of my knowledge and belie and correct and any attached copy is a true.	· = =
Jiawei Huang Jane Huang 5-/28/99 Name of Person Signing Signature Date		

Registration No. 43, 330

06/10/1999 NTHAI1 00000178 09321664

01 FC:581

40.00 OP

ASSIGNMENT

WHEREAS.

1. Yongming Li

2. Hongyi Chen

Xiaodong Wu

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: ARCHITECTURE OF DISCRETE WAVELET TRANSFORMATION

[] Filed:

Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, Winbond Electronics [H.K.] Ltd.

of Rm. 803, World Trade Square, Tower II, 123 Hoi Bun Road, Kwun Tung, Kowloon, Hong Kong

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assigner further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

-1-

PATENT PA

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: January Li

May 6, 1999

Sole or First Joint Inventor: Yongming Li

Hongyo Chen

May 6, 1999

Date:

Second Joint Inventor (if any): Hongyi Chen

Signature:

Signature:

May 6, 178

Third Joint Inventor (if any): Xiaodong Wu

400 0